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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	SCI, SPI
Peripherals	LVD, POR, PWM
Number of I/O	17
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	384 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 6x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	28-PDIP
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mc908gr4cpe

CGMXFC	1	28	V_{SSA}
OSC2	2	27	V_{DDA}
OSC1	3	26	PTA3/ $\overline{KBD3}$
\overline{RST}	4	25	PTA2/ $\overline{KBD2}$
PTE0/TxD	5	24	PTA1/ $\overline{KBD1}$
PTE1/RxD	6	23	PTA0/ $\overline{KBD0}$
\overline{IRQ}	7	22	V_{SSAD}/V_{REFL}
PTD0/ \overline{SS}	8	21	V_{DDAD}/V_{REFH}
PTD1/MISO	9	20	PTB3/AD3
PTD2/MOSI	10	19	PTB2/AD2
PTD3/SPSCK	11	18	PTB1/AD1
V_{SS}	12	17	PTB0/AD0
V_{DD}	13	16	PTD6/T2CH0
PTD4/T1CH0	14	15	PTD5/T1CH1

NOTE: Ports PTB4, PTB5, PTC0, and PTC1 are available only with the QFP.

Figure 1-3. DIP And SOIC Pin Assignments

1.6 Pin Functions

Descriptions of the pin functions are provided here.

1.6.1 Power Supply Pins (V_{DD} and V_{SS})

V_{DD} and V_{SS} are the power supply and ground pins. The MCU operates from a single power supply.

Fast signal transitions on MCU pins place high, short-duration current demands on the power supply. To prevent noise problems, take special care to provide power supply bypassing at the MCU as [Figure 1-4](#) shows. Place the C1 bypass capacitor as close to the MCU as possible. Use a high-frequency-response ceramic capacitor for C1. C2 is an optional bulk current bypass capacitor for use in applications that require the port pins to source high current levels.

Table 2-1. Vector Addresses

Vector Priority	Vector	Address	Vector
Lowest	IF16	\$FFDC	Timebase Vector (High)
		\$FFDD	Timebase Vector (Low)
	IF15	\$FFDE	ADC Conversion Complete Vector (High)
		\$FFDF	ADC Conversion Complete Vector (Low)
	IF14	\$FFE0	Keyboard Vector (High)
		\$FFE1	Keyboard Vector (Low)
	IF13	\$FFE2	SCI Transmit Vector (High)
		\$FFE3	SCI Transmit Vector (Low)
	IF12	\$FFE4	SCI Receive Vector (High)
		\$FFE5	SCI Receive Vector (Low)
	IF11	\$FFE6	SCI Error Vector (High)
		\$FFE7	SCI Error Vector (Low)
	IF10	\$FFE8	SPI Transmit Vector (High)
		\$FFE9	SPI Transmit Vector (Low)
	IF9	\$FFEA	SPI Receive Vector (High)
		\$FFEB	SPI Receive Vector (Low)
	IF8	\$FFEC	TIM2 Overflow Vector (High)
		\$FFED	TIM2 Overflow Vector (Low)
	IF7	\$FFEE	Reserved
		\$FFEF	Reserved
	IF6	\$FFF0	TIM2 Channel 0 Vector (High)
		\$FFF1	TIM2 Channel 0 Vector (Low)
	IF5	\$FFF2	TIM1 Overflow Vector (High)
		\$FFF3	TIM1 Overflow Vector (Low)
	IF4	\$FFF4	TIM1 Channel 1 Vector (High)
		\$FFF5	TIM1 Channel 1 Vector (Low)
	IF3	\$FFF6	TIM1 Channel 0 Vector (High)
		\$FFF7	TIM1 Channel 0 Vector (Low)
	IF2	\$FFF8	PLL Vector (High)
		\$FFF9	PLL Vector (Low)
	IF1	\$FFFA	IRQ Vector (High)
		\$FFFB	IRQ Vector (Low)
—	—	\$FFFC	SWI Vector (High)
		\$FFFD	SWI Vector (Low)
Highest	—	\$FFFE	Reset Vector (High)
		\$FFFF	Reset Vector (Low)

Section 3. Low Power Modes

3.1 Contents

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3.2 Introduction

The MCU may enter two low-power modes: wait mode and stop mode. They are common to all HC08 MCUs and are entered through instruction execution. This section describes how each module acts in the low-power modes.

- Overflow bit (OVRF) — The OVRF bit is set if software does not read the byte in the receive data register before the next full byte enters the shift register. The error interrupt enable bit, ERRIE, enables OVRF CPU interrupt requests. OVRF and ERRIE are in the SPI status and control register.

4.4.2.8 SCI

SCI CPU interrupt sources:

- SCI transmitter empty bit (SCTE) — SCTE is set when the SCI data register transfers a character to the transmit shift register. The SCI transmit interrupt enable bit, SCTIE, enables transmitter CPU interrupt requests. SCTE is in SCI status register 1. SCTIE is in SCI control register 2.
- Transmission complete bit (TC) — TC is set when the transmit shift register and the SCI data register are empty and no break or idle character has been generated. The transmission complete interrupt enable bit, TCIE, enables transmitter CPU interrupt requests. TC is in SCI status register 1. TCIE is in SCI control register 2.
- SCI receiver full bit (SCRF) — SCRF is set when the receive shift register transfers a character to the SCI data register. The SCI receive interrupt enable bit, SCRIE, enables receiver CPU interrupts. SCRF is in SCI status register 1. SCRIE is in SCI control register 2.
- Idle input bit (IDLE) — IDLE is set when 10 or 11 consecutive logic 1s shift in from the RxD pin. The idle line interrupt enable bit, ILIE, enables IDLE CPU interrupt requests. IDLE is in SCI status register 1. ILIE is in SCI control register 2.
- Receiver overrun bit (OR) — OR is set when the receive shift register shifts in a new character before the previous character was read from the SCI data register. The overrun interrupt enable bit, ORIE, enables OR to generate SCI error CPU interrupt requests. OR is in SCI status register 1. ORIE is in SCI control register 3.

5.8 I/O Registers

These I/O registers control and monitor ADC operation:

- ADC status and control register (ADSCR)
- ADC data register (ADR)
- ADC clock register (ADCLK)

5.8.1 ADC Status and Control Register

Function of the ADC status and control register (ADSCR) is described here.

Address: \$0003C

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	COCO/ IDMAS	AIEN	ADCO	ADCH4	ADCH3	ADCH2	ADCH1	ADCH0
Write:								
Reset:	0	0	0	1	1	1	1	1

Figure 5-2. ADC Status and Control Register (ADSCR)

COCO/IDMAS — Conversions Complete/Interrupt DMA Select Bit

When the AIEN bit is a logic 0, the COCO/IDMAS is a read-only bit which is set each time a conversion is completed except in the continuous conversion mode where it is set after the first conversion. This bit is cleared whenever the ADSCR is written or whenever the ADR is read.

If the AIEN bit is a logic 1, the COCO/IDMAS is a read/write bit which selects either CPU or DMA to service the ADC interrupt request. Reset clears this bit.

- 1 = Conversion completed (AIEN = 0)/DMA interrupt (AIEN = 1)
- 0 = Conversion not completed (AIEN = 0)/CPU interrupt (AIEN = 1)

CAUTION: *Because the MC68HC908GR8 does **NOT** have a DMA module, the IDMAS bit should **NEVER** be set when AIEN is set. Doing so will mask ADC interrupts and cause unwanted results.*

Analog-to-Digital Converter (ADC)

5.8.3 ADC Clock Register

The ADC clock register (ADCLK) selects the clock frequency for the ADC.

Address: \$0003E



Figure 5-4. ADC Clock Register (ADCLK)

ADIV2–ADIV0 — ADC Clock Prescaler Bits

ADIV2–ADIV0 form a 3-bit field which selects the divide ratio used by the ADC to generate the internal ADC clock. Table 5-2 shows the available clock configurations. The ADC clock should be set to approximately 1 MHz.

Table 5-2. ADC Clock Divide Ratio

ADIV2	ADIV1	ADIV0	ADC Clock Rate
0	0	0	ADC input clock ÷ 1
0	0	1	ADC input clock ÷ 2
0	1	0	ADC input clock ÷ 4
0	1	1	ADC input clock ÷ 8
1	X	X	ADC input clock ÷ 16

X = don't care

ADICLK — ADC Input Clock Select Bit

ADICLK selects either the bus clock or CGMXCLK as the input clock source to generate the internal ADC clock. Reset selects CGMXCLK as the ADC clock source.

Central Processing Unit (CPU)

Table 10-1. Instruction Set Summary (Continued)

Source Form	Operation	Description	Effect on CCR						Address Mode	Opcode	Operand	Cycles
			V	H	I	N	Z	C				
NEG <i>opr</i> NEGA NEGX NEG <i>opr,X</i> NEG ,X NEG <i>opr,SP</i>	Negate (Two's Complement)	$M \leftarrow -(M) = \$00 - (M)$ $A \leftarrow -(A) = \$00 - (A)$ $X \leftarrow -(X) = \$00 - (X)$ $M \leftarrow -(M) = \$00 - (M)$ $M \leftarrow -(M) = \$00 - (M)$	↑	-	-	↑	↑	↑	DIR INH INH IX1 IX SP1	30 40 50 60 70 9E60	dd ff ff	4 1 1 4 3 5
NOP	No Operation	None	-	-	-	-	-	-	INH	9D		1
NSA	Nibble Swap A	$A \leftarrow (A[3:0]:A[7:4])$	-	-	-	-	-	-	INH	62		3
ORA # <i>opr</i> ORA <i>opr</i> ORA <i>opr</i> ORA <i>opr,X</i> ORA <i>opr,X</i> ORA ,X ORA <i>opr,SP</i> ORA <i>opr,SP</i>	Inclusive OR A and M	$A \leftarrow (A) (M)$	0	-	-	↑	↑	-	IMM DIR EXT IX2 IX1 IX SP1 SP2	AA BA CA DA EA FA 9EEA 9EDA	ii dd hh ll ee ff ff ff ee ff	2 3 4 4 3 2 4 5
PSHA	Push A onto Stack	Push (A); $SP \leftarrow (SP) - 1$	-	-	-	-	-	-	INH	87		2
PSHH	Push H onto Stack	Push (H); $SP \leftarrow (SP) - 1$	-	-	-	-	-	-	INH	8B		2
PSHX	Push X onto Stack	Push (X); $SP \leftarrow (SP) - 1$	-	-	-	-	-	-	INH	89		2
PULA	Pull A from Stack	$SP \leftarrow (SP) + 1$; Pull (A)	-	-	-	-	-	-	INH	86		2
PULH	Pull H from Stack	$SP \leftarrow (SP) + 1$; Pull (H)	-	-	-	-	-	-	INH	8A		2
PULX	Pull X from Stack	$SP \leftarrow (SP) + 1$; Pull (X)	-	-	-	-	-	-	INH	88		2
ROL <i>opr</i> ROLA ROLX ROL <i>opr,X</i> ROL ,X ROL <i>opr,SP</i>	Rotate Left through Carry		↑	-	-	↑	↑	↑	DIR INH INH IX1 IX SP1	39 49 59 69 79 9E69	dd ff ff	4 1 1 4 3 5
ROR <i>opr</i> RORA RORX ROR <i>opr,X</i> ROR ,X ROR <i>opr,SP</i>	Rotate Right through Carry		↑	-	-	↑	↑	↑	DIR INH INH IX1 IX SP1	36 46 56 66 76 9E66	dd ff ff	4 1 1 4 3 5
RSP	Reset Stack Pointer	$SP \leftarrow \$FF$	-	-	-	-	-	-	INH	9C		1
RTI	Return from Interrupt	$SP \leftarrow (SP) + 1$; Pull (CCR) $SP \leftarrow (SP) + 1$; Pull (A) $SP \leftarrow (SP) + 1$; Pull (X) $SP \leftarrow (SP) + 1$; Pull (PCH) $SP \leftarrow (SP) + 1$; Pull (PCL)	↑	↑	↑	↑	↑	↑	INH	80		7
RTS	Return from Subroutine	$SP \leftarrow SP + 1$; Pull (PCH) $SP \leftarrow SP + 1$; Pull (PCL)	-	-	-	-	-	-	INH	81		4

The IRQF bit in the INTSCR register can be used to check for pending interrupts. The IRQF bit is not affected by the IMASK bit, which makes it useful in applications where polling is preferred.

Use the BIH or BIL instruction to read the logic level on the $\overline{\text{IRQ1}}$ pin.

NOTE: *When using the level-sensitive interrupt trigger, avoid false interrupts by masking interrupt requests in the interrupt routine.*

12.6 IRQ Module During Break Interrupts

The BCFE bit in the SIM break flag control register (SBFCR) enables software to clear the latch during the break state. See [Break Module \(BRK\)](#).

To allow software to clear the IRQ latch during a break interrupt, write a logic 1 to the BCFE bit. If a latch is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect CPU interrupt flags during the break state, write a logic 0 to the BCFE bit. With BCFE at logic 0 (its default state), writing to the ACK bit in the IRQ status and control register during the break state has no effect on the IRQ interrupt flags.

16.5.2 Data Direction Register C

Data direction register C (DDRC) determines whether each port C pin is an input or an output. Writing a logic 1 to a DDRC bit enables the output buffer for the corresponding port C pin; a logic 0 disables the output buffer.

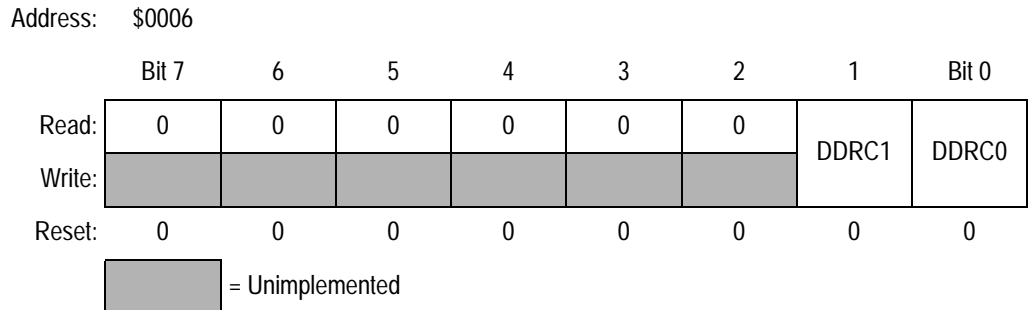


Figure 16-10. Data Direction Register C (DDRC)

DDRC1–DDRC0 — Data Direction Register C Bits

These read/write bits control port C data direction. Reset clears DDRC1–DDRC0, configuring all port C pins as inputs.

- 1 = Corresponding port C pin configured as output
- 0 = Corresponding port C pin configured as input

NOTE: Avoid glitches on port C pins by writing to the port C data register before changing data direction register C bits from 0 to 1.

Figure 16-11 shows the port C I/O logic.

NOTE: For those devices packaged in a 28-pin DIP and SOIC package, PTC1,0 are not connected. Set DDRC1,0 to a 1 to configure PTC1,0 as outputs.

16.5.3 Port C Input Pullup Enable Register

The port C input pullup enable register (PTCPUE) contains a software configurable pullup device for each of the two port C pins. Each bit is individually configurable and requires that the data direction register, DDRC, bit be configured as an input. Each pullup is automatically and dynamically disabled when a port bit's DDRC is configured for output mode.

Address: \$000E

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	0	0	0	0	0	0	PTCPUE1	PTCPUE0
Write:								
Reset:	0	0	0	0	0	0	0	0

= Unimplemented

Figure 16-12. Port C Input Pullup Enable Register (PTCPUE)

PTCPUE1–PTCPUE0 — Port C Input Pullup Enable Bits

These writeable bits are software programmable to enable pullup devices on an input port bit.

- 1 = Corresponding port C pin configured to have internal pullup
- 0 = Corresponding port C pin internal pullup disconnected

With the misaligned character shown in [Figure 18-7](#), the receiver counts 170 RT cycles at the point when the count of the transmitting device is 10 bit times \times 16 RT cycles + 3 RT cycles = 163 RT cycles.

The maximum percent difference between the receiver count and the transmitter count of a slow 9-bit character with no errors is

$$\left| \frac{170 - 163}{170} \right| \times 100 = 4.12\%$$

18.5.3.7 Fast Data Tolerance

[Figure 18-8](#) shows how much a fast received character can be misaligned without causing a noise error or a framing error. The fast stop bit ends at RT10 instead of RT16 but is still there for the stop bit data samples at RT8, RT9, and RT10.

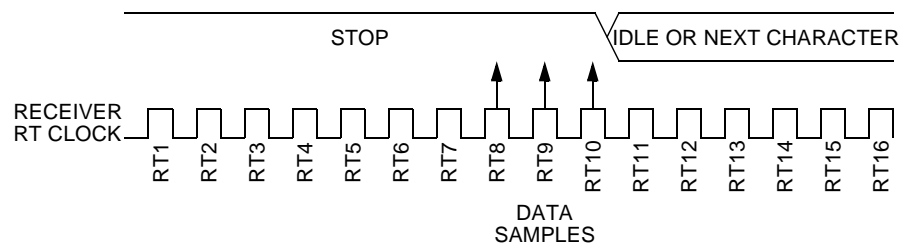


Figure 18-8. Fast Data

For an 8-bit character, data sampling of the stop bit takes the receiver 9 bit times \times 16 RT cycles + 10 RT cycles = 154 RT cycles.

With the misaligned character shown in [Figure 18-8](#), the receiver counts 154 RT cycles at the point when the count of the transmitting device is 10 bit times \times 16 RT cycles = 160 RT cycles.

The maximum percent difference between the receiver count and the transmitter count of a fast 8-bit character with no errors is

$$\left| \frac{154 - 160}{154} \right| \times 100 = 3.90\%$$

Serial Communications Interface (SCI)

Address: \$0014

	Bit 7	6	5	4	3	2	1	Bit 0
Read:								
Write:	SCTIE	TCIE	SCRIE	ILIE	TE	RE	RWU	SBK
Reset:	0	0	0	0	0	0	0	0

Figure 18-10. SCI Control Register 2 (SCC2)

SCTIE — SCI Transmit Interrupt Enable Bit

This read/write bit enables the SCTE bit to generate SCI transmitter CPU interrupt requests. Reset clears the SCTIE bit.

- 1 = SCTE enabled to generate CPU interrupt
- 0 = SCTE not enabled to generate CPU interrupt

TCIE — Transmission Complete Interrupt Enable Bit

This read/write bit enables the TC bit to generate SCI transmitter CPU interrupt requests. Reset clears the TCIE bit.

- 1 = TC enabled to generate CPU interrupt requests
- 0 = TC not enabled to generate CPU interrupt requests

SCRIE — SCI Receive Interrupt Enable Bit

This read/write bit enables the SCRF bit to generate SCI receiver CPU interrupt requests. Reset clears the SCRIE bit.

- 1 = SCRF enabled to generate CPU interrupt
- 0 = SCRF not enabled to generate CPU interrupt

ILIE — Idle Line Interrupt Enable Bit

This read/write bit enables the IDLE bit to generate SCI receiver CPU interrupt requests. Reset clears the ILIE bit.

- 1 = IDLE enabled to generate CPU interrupt requests
- 0 = IDLE not enabled to generate CPU interrupt requests

TE — Transmitter Enable Bit

Setting this read/write bit begins the transmission by sending a preamble of 10 or 11 logic 1s from the transmit shift register to the PE2/TxD pin. If software clears the TE bit, the transmitter completes any transmission in progress before the PE2/TxD returns to the idle

Section 19. System Integration Module (SIM)

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19.2 Introduction

This section describes the system integration module (SIM). Together with the CPU, the SIM controls all MCU activities. A block diagram of the SIM is shown in [Figure 19-1](#). [Table 19-1](#) is a summary of the SIM input/output (I/O) registers. The SIM is a system state controller that coordinates CPU and exception timing. The SIM is responsible for:

- Bus clock generation and control for CPU and peripherals:
 - Stop/wait/reset/break entry and recovery
 - Internal clock control
- Master reset control, including power-on reset (POR) and COP timeout
- Interrupt control:
 - Acknowledge timing
 - Arbitration control timing

The full names of the SPI I/O pins are shown in [Table 20-1](#). The generic pin names appear in the text that follows.

Table 20-1. Pin Name Conventions

SPI Generic Pin Names:		MISO	MOSI	\overline{SS}	SPSCK	CGND
Full SPI Pin Names:	SPI	PTD1/ATD9	PTD2/ATD10	PTD0/ATD8	PTD3/ATD11	V _{SS}

20.5 Functional Description

[Figure 20-1](#) summarizes the SPI I/O registers and [Figure 20-2](#) shows the structure of the SPI module.

Addr.	Register Name	Bit 7	6	5	4	3	2	1	Bit 0	
\$0010	SPI Control Register (SPCR)	Read:	SPRIE	DMAS	SPMSTR	CPOL	CPHA	SPWOM	SPE	SPTIE
		Write:								
		Reset:	0	0	1	0	1	0	0	0
\$0011	SPI Status and Control Register (SPSCR)	Read:	SPRF	ERRIE	OVRF	MODF	SPTIE	MODFEN	SPR1	SPR0
		Write:								
		Reset:	0	0	0	0	1	0	0	0
\$0012	SPI Data Register (SPDR)	Read:	R7	R6	R5	R4	R3	R2	R1	R0
		Write:	T7	T6	T5	T4	T3	T2	T1	T0
		Reset:	Unaffected by reset							

= Unimplemented

Figure 20-1. SPI I/O Register Summary

Serial Peripheral Interface (SPI)

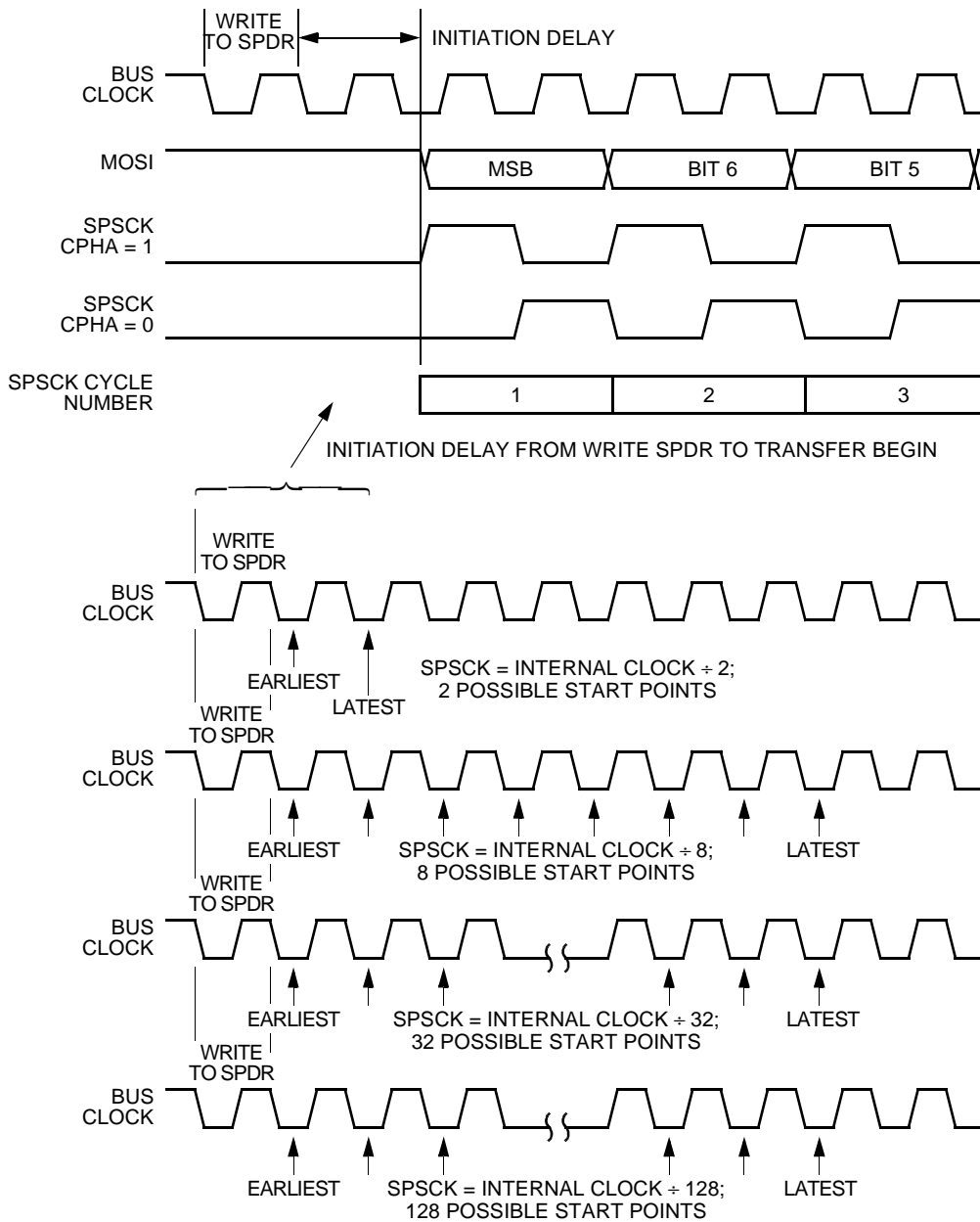


Figure 20-7. Transmission Start Delay (Master)

20.7 Queuing Transmission Data

The double-buffered transmit data register allows a data byte to be queued and transmitted. For an SPI configured as a master, a queued data byte is transmitted immediately after the previous transmission has completed. The SPI transmitter empty flag (SPTE) indicates when the transmit data buffer is ready to accept new data. Write to the transmit data register only when the SPTE bit is high. Figure 20-8 shows the timing associated with doing back-to-back transmissions with the SPI (SPSCK has CPHA: CPOL = 1:0).

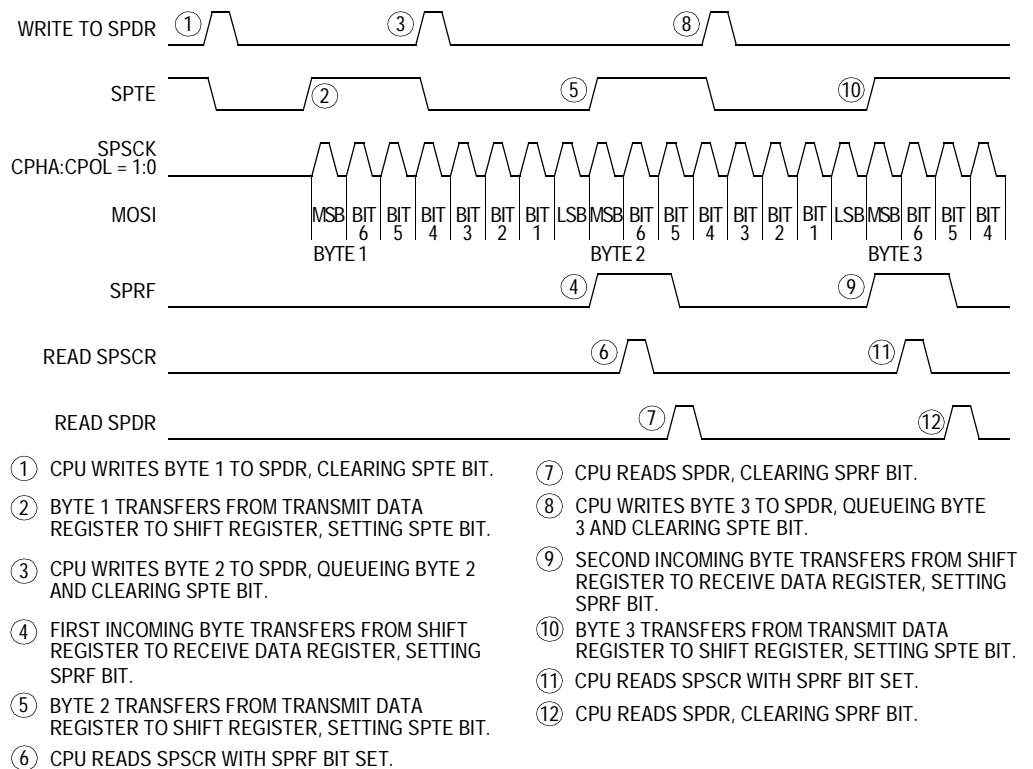


Figure 20-8. .SPRF/SPTE CPU Interrupt Timing

The transmit data buffer allows back-to-back transmissions without the slave precisely timing its writes between transmissions as in a system with a single data buffer. Also, if no new data is written to the data buffer, the last value contained in the shift register is the next data word to be transmitted.

20.12 SPI During Break Interrupts

The system integration module (SIM) controls whether status bits in other modules can be cleared during the break state. The BCFE bit in the SIM break flag control register (SBFCR) enables software to clear status bits during the break state. See [System Integration Module \(SIM\)](#).

To allow software to clear status bits during a break interrupt, write a logic 1 to the BCFE bit. If a status bit is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect status bits during the break state, write a logic 0 to the BCFE bit. With BCFE at logic 0 (its default state), software can read and write I/O registers during the break state without affecting status bits. Some status bits have a 2-step read/write clearing procedure. If software does the first step on such a bit before the break, the bit cannot change during the break state as long as BCFE is at logic 0. After the break, doing the second step clears the status bit.

Since the SPTE bit cannot be cleared during a break with the BCFE bit cleared, a write to the transmit data register in break mode does not initiate a transmission nor is this data transferred into the shift register. Therefore, a write to the SPDR in break mode with the BCFE bit cleared has no effect.

20.13 I/O Signals

The SPI module has five I/O pins and shares four of them with a parallel I/O port. They are:

- MISO — Data received
- MOSI — Data transmitted
- SPCK — Serial clock
- \overline{SS} — Slave select
- CGND — Clock ground (internally connected to V_{SS})

The SPI has limited inter-integrated circuit (I²C) capability (requiring software support) as a master in a single-master environment. To

Address: \$0011

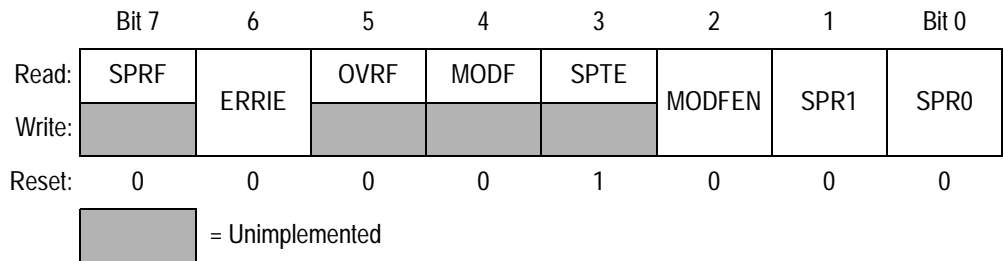


Figure 20-14. SPI Status and Control Register (SPSCR)

SPRF — SPI Receiver Full Bit

This clearable, read-only flag is set each time a byte transfers from the shift register to the receive data register. SPRF generates a CPU interrupt request if the SPRIE bit in the SPI control register is set also. During an SPRF CPU interrupt, the CPU clears SPRF by reading the SPI status and control register with SPRF set and then reading the SPI data register.

Reset clears the SPRF bit.

- 1 = Receive data register full
- 0 = Receive data register not full

ERRIE — Error Interrupt Enable Bit

This read/write bit enables the MODF and OVRF bits to generate CPU interrupt requests. Reset clears the ERRIE bit.

- 1 = MODF and OVRF can generate CPU interrupt requests
- 0 = MODF and OVRF cannot generate CPU interrupt requests

OVRF — Overflow Bit

This clearable, read-only flag is set if software does not read the byte in the receive data register before the next full byte enters the shift register. In an overflow condition, the byte already in the receive data register is unaffected, and the byte that shifted in last is lost. Clear the OVRF bit by reading the SPI status and control register with OVRF set and then reading the receive data register. Reset clears the OVRF bit.

- 1 = Overflow
- 0 = No overflow

Table 23-5. 3.0 V DC Electrical Characteristics

Characteristic ⁽¹⁾	Symbol	Min	Typ ⁽²⁾	Max	Unit
Pullup resistors (as input only) Ports PTA3/KBD37–PTA0/KBD0, PTC1–PTC0, PTD6/T2CH0–PTD0/SS	R _{PU}	20	45	65	kΩ
Capacitance Ports (as input or output)	C _{Out} C _{In}	— —	— —	12 8	pF
Monitor mode entry voltage	V _{TST}	V _{DD} + 2.5	—	8	V
Low-voltage inhibit, trip falling voltage – target	V _{TRIPF}	2.35	2.60	2.70	V
Low-voltage inhibit, trip rising voltage – target	V _{TRIPR}	2.45	2.66	2.80	V
Low-voltage inhibit reset/recover hysteresis – target (V _{TRIPF} + V _{HYS} = V _{TRIPR})	V _{HYS}	—	60	—	mV
POR rearm voltage ⁽⁸⁾	V _{POR}	0	—	100	mV
POR reset voltage ⁽⁹⁾	V _{PORRST}	0	700	800	mV
POR rise time ramp rate ⁽¹⁰⁾	R _{POR}	0.02	—	—	V/ms

Notes:

- V_{DD} = 3.0 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H, unless otherwise noted
- Typical values reflect average measurements at midpoint of voltage range, 25 °C only.
- Run (operating) I_{DD} measured using external square wave clock source (f_{OSC} = 16.4 MHz). All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. C_L = 20 pF on OSC2. All ports configured as inputs. OSC2 capacitance linearly affects run I_{DD}. Measured with all modules enabled.
- Wait I_{DD} measured using external square wave clock source (f_{OSC} = 16.4 MHz). All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. C_L = 20 pF on OSC2. All ports configured as inputs. OSC2 capacitance linearly affects wait I_{DD}. Measured with PLL and LVI enabled.
- Stop I_{DD} is measured with OSC1 = V_{SS}.
- Stop I_{DD} with TBM enabled is measured using an external square wave clock source (f_{OSC} = 32.8 KHz). All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. All inputs configured as inputs.
- Pullups and pulldowns are disabled.
- Maximum is highest voltage that POR is guaranteed.
- Maximum is highest voltage that POR is possible.
- If minimum V_{DD} is not reached before the internal POR reset is released, $\overline{\text{RST}}$ must be driven low externally until minimum V_{DD} is reached.

Glossary

LVI — See "low voltage inhibit module (LVI)."

M68HC08 — A Motorola family of 8-bit MCUs.

mark/space — The logic 1/logic 0 convention used in formatting data in serial communication.

mask — 1. A logic circuit that forces a bit or group of bits to a desired state. 2. A photomask used in integrated circuit fabrication to transfer an image onto silicon.

mask option — A optional microcontroller feature that the customer chooses to enable or disable.

mask option register (MOR) — An EPROM location containing bits that enable or disable certain MCU features.

MCU — Microcontroller unit. See "microcontroller."

memory location — Each M68HC08 memory location holds one byte of data and has a unique address. To store information in a memory location, the CPU places the address of the location on the address bus, the data information on the data bus, and asserts the write signal. To read information from a memory location, the CPU places the address of the location on the address bus and asserts the read signal. In response to the read signal, the selected memory location places its data onto the data bus.

memory map — A pictorial representation of all memory locations in a computer system.

microcontroller — Microcontroller unit (MCU). A complete computer system, including a CPU, memory, a clock oscillator, and input/output (I/O) on a single integrated circuit.

modulo counter — A counter that can be programmed to count to any number from zero to its maximum possible modulus.

monitor ROM — A section of ROM that can execute commands from a host computer for testing purposes.

MOR — See "mask option register (MOR)."

most significant bit (MSB) — The leftmost digit of a binary number.

multiplexer — A device that can select one of a number of inputs and pass the logic level of that input on to the output.

N — The negative bit in the condition code register of the CPU08. The CPU sets the negative bit when an arithmetic operation, logical operation, or data manipulation produces a negative result.

nibble — A set of four bits (half of a byte).